



1204.40319X00

*IFW*

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: T. UCHIDA, et al.  
Application No.: 09/869,347  
Filed: SEPTEMBER 7, 2001  
For: MATERIALS FOR POLISHING LIQUID FOR METAL,  
POLISHING LIQUID FOR METAL, METHOD FOR  
PREPARATION THEREOF AND POLISHING METHOD USING  
THE SAME  
Group AU: 2813  
Examiner: L. M. Schillinger  
Confirm. No: 4090

**AMENDMENT**

**Mail Stop: AMEND – NO FEE**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

December 18, 2006

Sir:

In response to the Office Action mailed October 16, 2006, please amend the above-identified application as listed in the following, and as set forth on the following pages:

AMENDMENTS TO THE CLAIMS; and

REMARKS are included following the amendments.